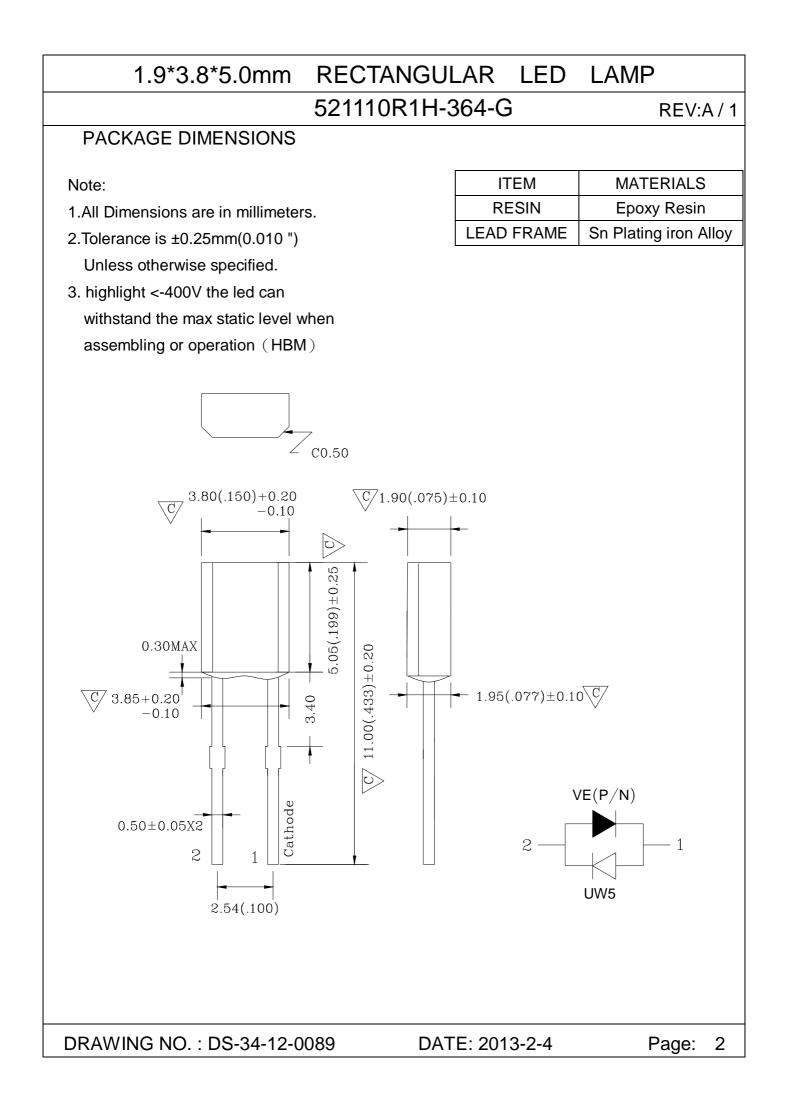
DATA SHEET		
PART NO.: 521110R1H-364-G		
REV: <u>A/1</u>		
PARA LIGHT ENGINEERING: CUSTOMER'S APPROVAL: DCC:		
DRAWING NO. : DS-34-12-0089 DATE: 2013-2-4	Page:	1

ſ



## 521110R1H-364-G

REV:A/1

#### FEATURES

- \* High-brightness
- \* High reliability
- \* Low-voltage characteristics
- \* Wide Viewing Angle
- \* Pb FREE Products
- \* RoHS Compliant

### CHIP MATERIALS

- \* Dice Material : GaInN& GaIAInP/GaAs
- \* Light Color : MULTICOLOR (COOL WHITE & AMBER)
- \* Lens Color : WHITE DIFFUSED

### ABSOLUTE MAXIMUM RATING:(Ta=25°C)

SYMBOL	DESCRIPTION	COOL WHITE	AMBER	UNIT	
PD	Power Dissipation	120	85	mW	
Vr	Reverse Voltage	5	5	V	
IF	Average Forward Current	30	30	mA	
IPF	Peak Forward Current (Duty=0.1,1KHZ)	-	80	mA	
-	Derating Linear From 25°C	0.4	0.40	mA/°C	
Topr	Operating Temperature Range	-25°C to 85°C			
Tstg	Storage Temperature Range	-25°C to 85°C			

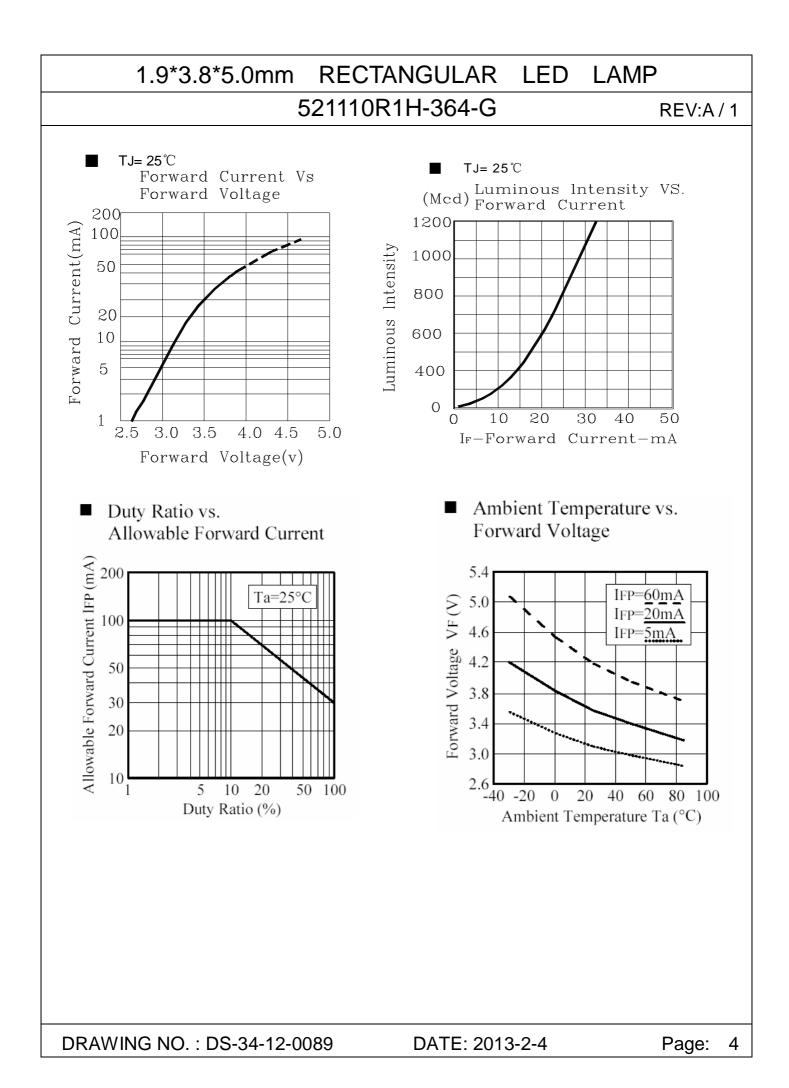
IFP Condition : Pulse Width≤10msec, 10% duty cycle

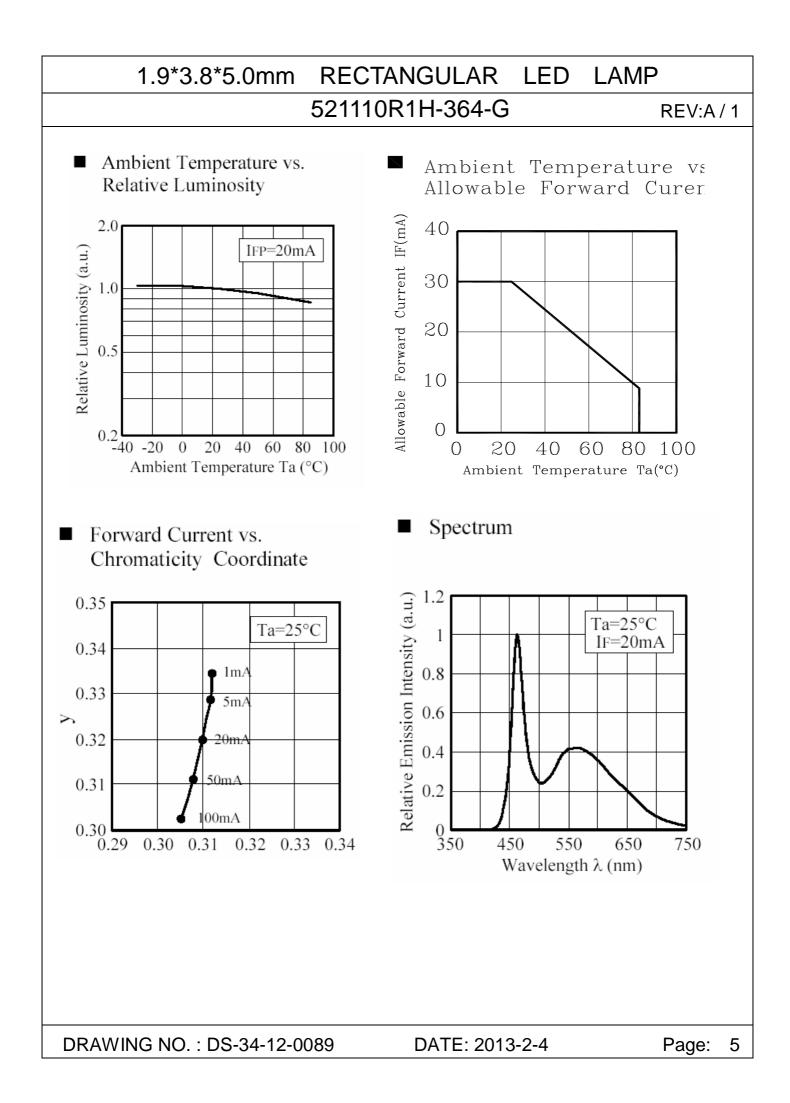
### ELECTRO-OPTICAL CHARACTERISTICS:(Ta=25°C)

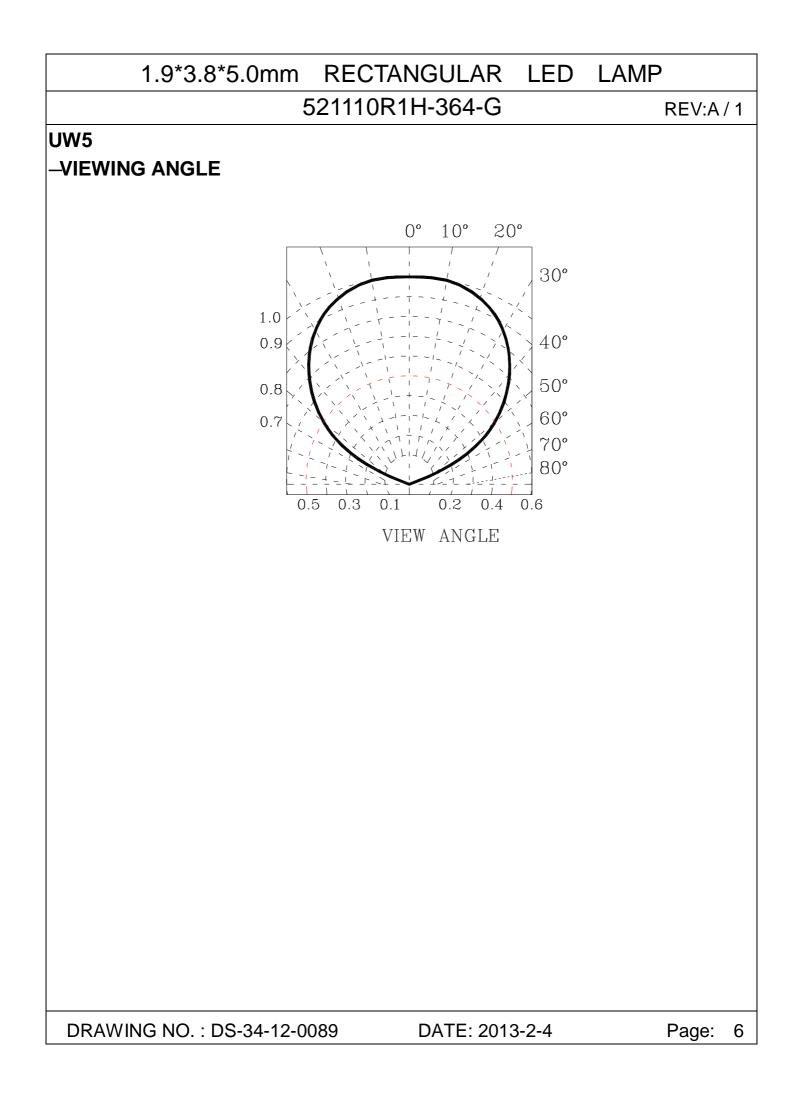
SYMBOL	PARAMETER	TEST C	MIN.	TYP.	MAX.	UNIT	
VF	Forward Voltage	IF=20mA	Cool White	2.8	3.3	3.7	V
			Amber	1.8	2.0	2.6	V
lD	Dominant Wavelength	IF=20mA	Amber	600		610	nm
Δ1	Spectral Line Half-Width	IF=20mA Amber			17		nm
201/2	Half Intensity Angle	IF=20mA	Cool White		100		deg
			Amber		100		deg
١v	Luminous Intensity	IF=20mA	Cool White	400	600	1150	mcd
			Amber	37.6	80	192.4	mcd
Х	Chromaticity Coordinates	IF = 20mA	Cool White		0.28		
Y	Onioniationy Obordinates	IF = 20mA			0.27		

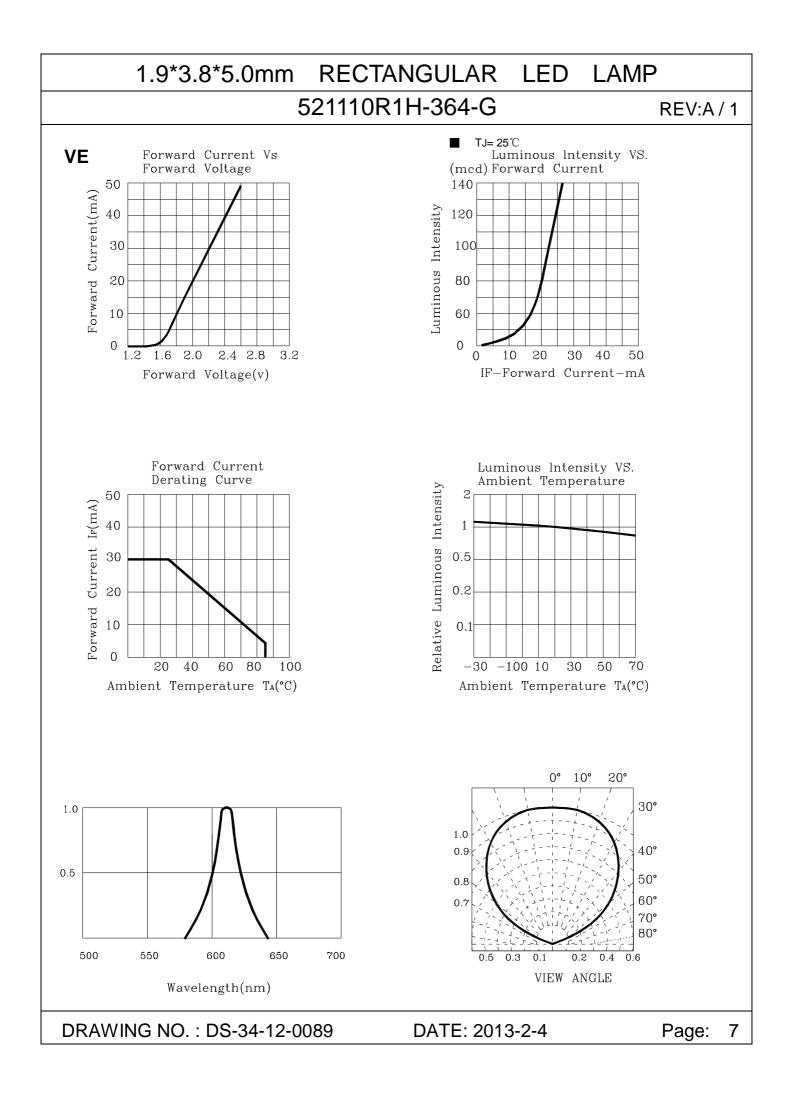
DRAWING NO. : DS-34-12-0089

DATE: 2013-2-4









## 521110R1H-364-G

REV:A/1

### Label Explanation

PART	NO.	:		
LOT	NO.	• •		INSPECTED
BIN		•		
Q'	ΤY	•	PCS	
N. W		* *	g	

### PARA NO. : 521110R1H-364-G Refer to page 17

LOT NO.:E L L 4 7 0009 A B C D E F

A---E: For Serial number

B---L: Local F: Foreign

C---L: LAMP

D---Year

E---Month

F---Serial number

DRAWING NO. : DS-34-12-0089

DATE: 2013-2-4

Page: 8

### 521110R1H-364-G

REV:A/1

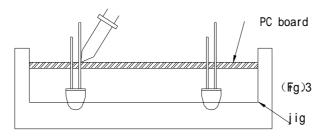
#### SOLDERING METHOD SOLDERING CONDITIONS REMARK -Solder no closer than 3mm from the IR Bath temperature: 260 °C REFLOW base of the package Immersion time: with 5 sec ,1 times -Using soldering flux," RESIN FLUX" is recommended. DIP Bath temperature: 260 °C -Attached data of temperatuare cure SOLDERING Immersion time: with 5 sec ,1 times for your reference on page 15 -During soldering, take care not to press the tip of iron against the Soldering iron: 30W or smaller lead. SOLDERING Temperature at tip of iron: $300^{\circ}$ or lower (To prevent heat from being IRON Soldering time: min 3 sec. transferred directly to the lead, hold the lead with a pair of tweezers while soldering) 1) When soldering the lead of LED in a condition that the package is fixed with a panel (See Fig.1), be careful not to stress the leads with iron tip. 0 lead wries (Fig.1) Pane I 2) When soldering wire to the lead, work with a jig (See Fig.2) to avoid stressing the package. 0 Lead wries Leave a slight clearance (Fig.2) Regarding tinning the leads, compound made of tin, copper and sliver is proposed with the

temperature of  $260^{\circ}$ C. The proportion of the alloyed solution is 95.5% tin, 3.5% copper, 0.5% silver. The time of tinning is 3 seconds.

### 521110R1H-364-G

REV:A/1

3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid stressing the leads (See Fig.3).



- Repositioning after soldering should be avoided as much as possible. If inevitable: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

### -STORAGE

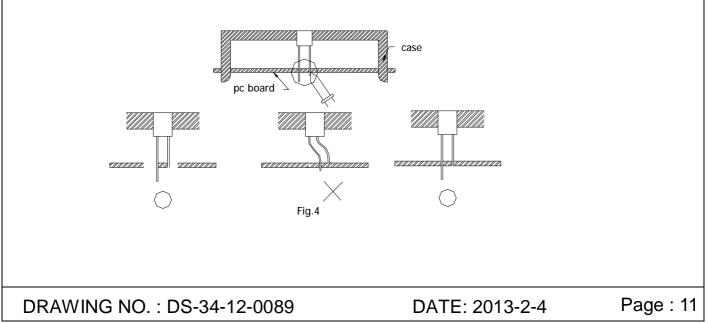
0

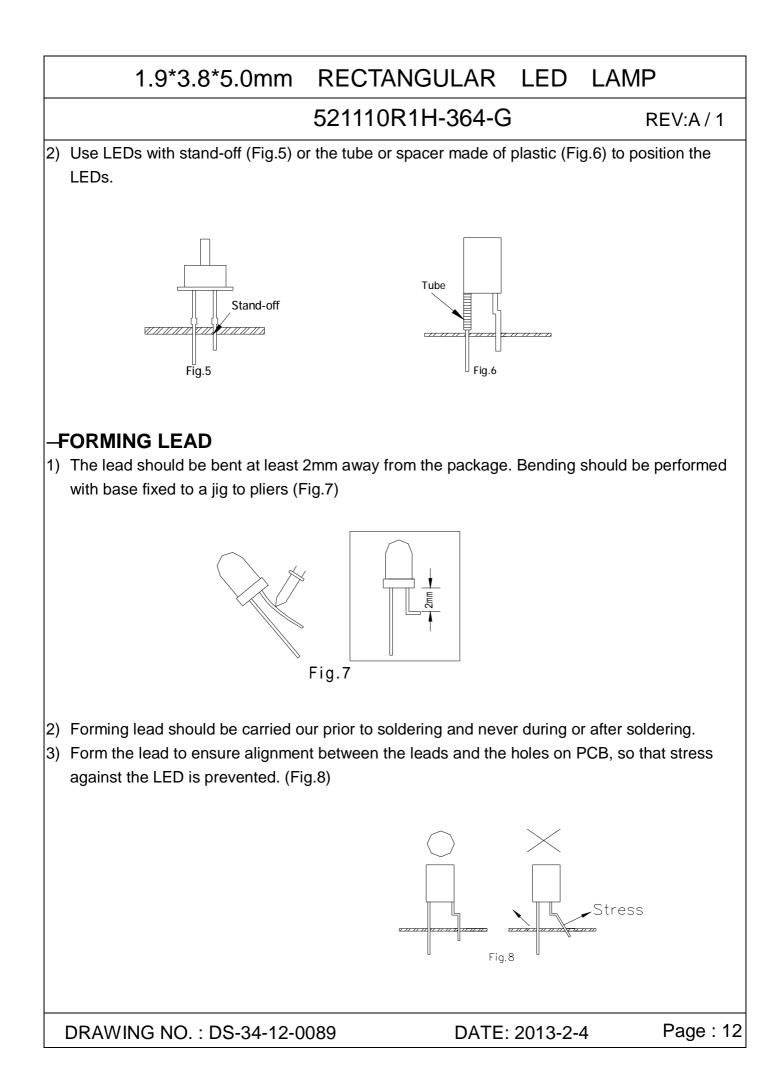
- 1) The LEDs should be stored at  $30^{\circ}$ C or less and 70% RH or less after being shipped from PARA and the storage life limit is 1 year .
- 2) PARA LED lead frames are comprised of a tin plated iron alloy. The surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- 3) Please avoid rapid changes in ambient temperature, especially, in high humidity environments where condensation can occur.

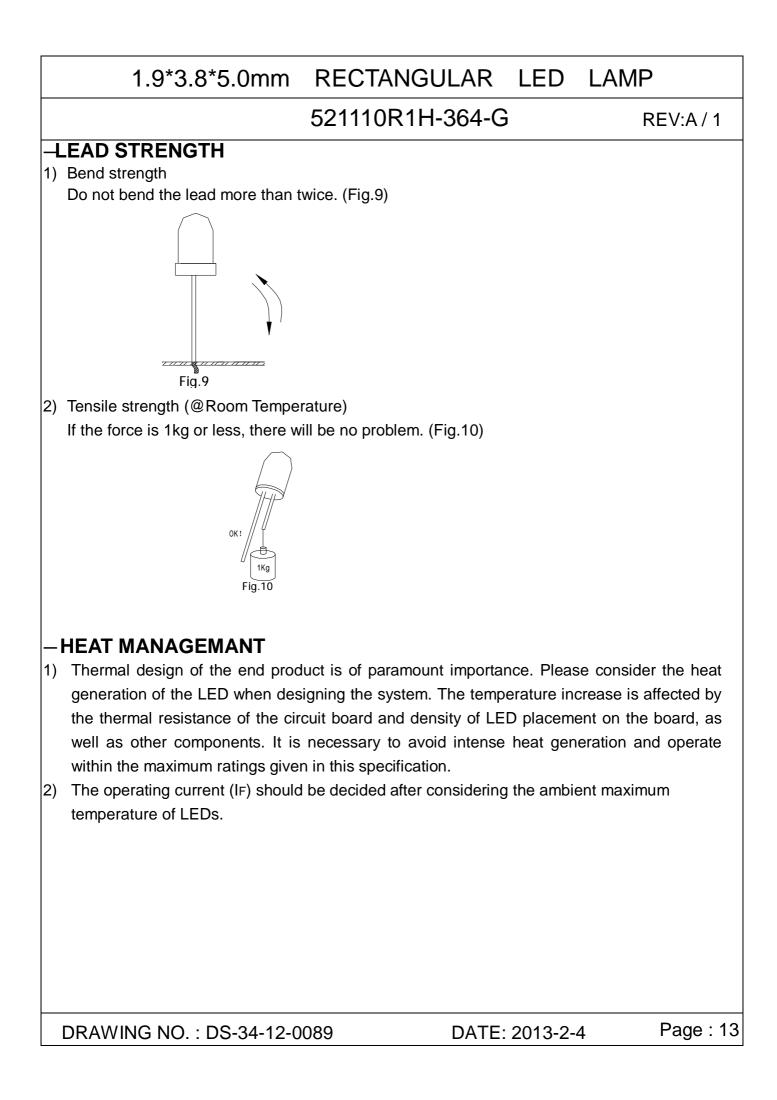
#### RECTANGULAR LED 1.9\*3.8\*5.0mm LAMP 521110R1H-364-G REV:A/1 STATIC ELECTRICITY 1) Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band and an anti-electrostatic glove be used when handling the LEDs. 2) All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the LED mounting equipment. 3) When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity. To find static-damaged LEDs, perform a light-on test or a VF test at a lower current (below 1mA is recommended). 4) Damaged LEDs will show some unusual characteristics such as the leakage current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria : (VF>2.0V at IF=0.5mA)

#### -LED MOUNTING METHOD

1) When mounting the LED to a housing, as shown on Fig.4, ensure that the mounting holes on the PC board match the pitch of the leads correctly. Tolerance of dimensions of the respective components including the LEDs should be taken into account especially when designing the housing, PC board, etc. to prevent pitch misalignment between the leads and holes on PCB, the diameter of the holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes could be made oval. (See Fig.4)







## 521110R1H-364-G

REV:A/1

#### -CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- When washing is required, refer to the following table for the proper chemical to be used. (Immersion time: within 3 minutes at room temperature.)

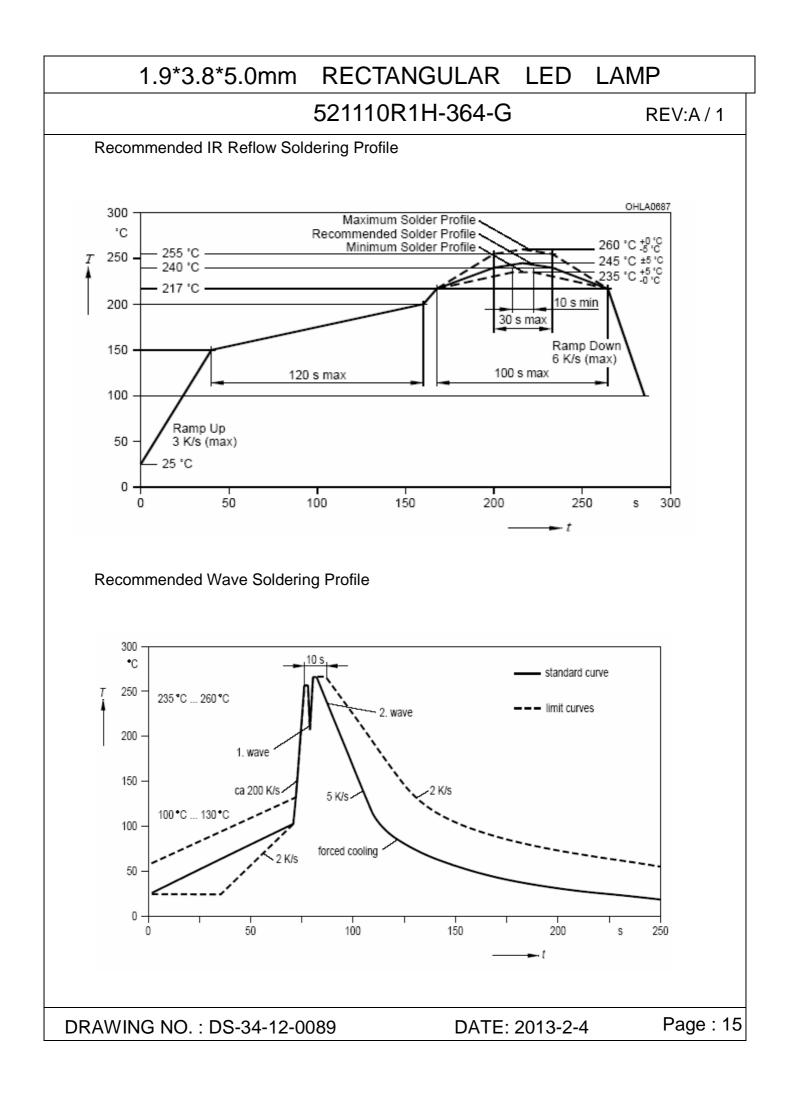
SOLVENT	ADAPTABILITY
Freon TE	$\odot$
Chlorothene	$\times$
Isopropyl Alcohol	$\odot$
Thinner	$\times$
Acetone	$\times$
Trichloroethylene	×

NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on factors such as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed by confirming an ultrasonic cleaning trial run.

 $\odot$ --Usable  $\times$ --Do not use.

### -OTHER CONSIDERTIONS

- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- 2) The LEDs described in this data sheet are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, spacecraft, automobiles, traffic control equipment etc).
- 3) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.



# 521110R1H-364-G

REV:A/1

# Bin Code List:

Luminous Intensity(IV), Unit:mcd@20mA					
Bin Code(VE) Min Max					
М	37.6	192.4			

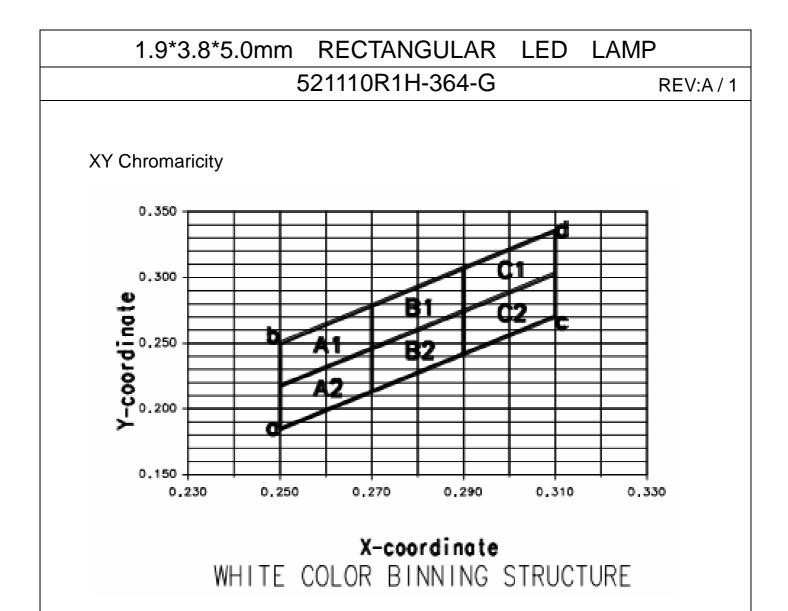
Tolerance of each bin are±15%

Luminous Intensity(IV), Unit:mcd@20mA						
Bin	Min	Max				
Code(UW5)						
L	400	520				
М	520	680				
Ν	680	880				
Р	880	1150				

Tolerance of each bin are±15%

DRAWING NO. : DS-34-12-0089

DATE: 2013-2-4



	Bin		Spec.Range						
	Code	<b>X</b> 1	<b>y</b> 1	X2	Y2	Хз	Y <sub>3</sub>	<b>X</b> 4	<b>Y</b> 4
	A1	0.2700	0.2455	0.2700	0.2780	0.2500	0.2500	0.2500	0.2175
White	A2	0.2700	0.2455	0.2700	0.2130	0.2500	0.1850	0.2500	0.2175
	B1	0.2700	0.2455	0.2700	0.2780	0.2900	0.3060	0.2900	0.2735
	B2	0.2700	0.2455	0.2700	0.2130	0.2900	0.2410	0.2900	0.2735
	C1	0.2900	0.3060	0.3100	0.3355	0.3100	0.3030	0.2900	0.2735
	C2	0.2900	0.2410	0.3100	0.2705	0.3100	0.3030	0.2900	0.2735

COLOR MEASUREMENT ALLOWANCE IS+0.01

DRAWING NO. : DS-34-12-0089

DATE: 2013-2-4

Page: 17